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(12) **United States Design Patent**
Arimoto

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(54) **EARPHONE**

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(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205; D24/174
CPC H04R 1/10; H04R 25/00; H04R 1/1016;
H04R 1/1041; H04R 5/033; H04R
5/0335; H04R 1/1033
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an earphone, FIG. 2 is a front elevational view thereof, FIG. 3 is a rear elevational view thereof, FIG. 4 is a top plan view thereof, FIG. 5 is a bottom plan view thereof, FIG. 6 is a left side elevational view thereof; and, FIG. 7 is a right side elevational view thereof. The broken lines in the drawings are for the purpose of illustrating portions of the earphone that form no part of the claimed design.

1 Claim, 5 Drawing Sheets

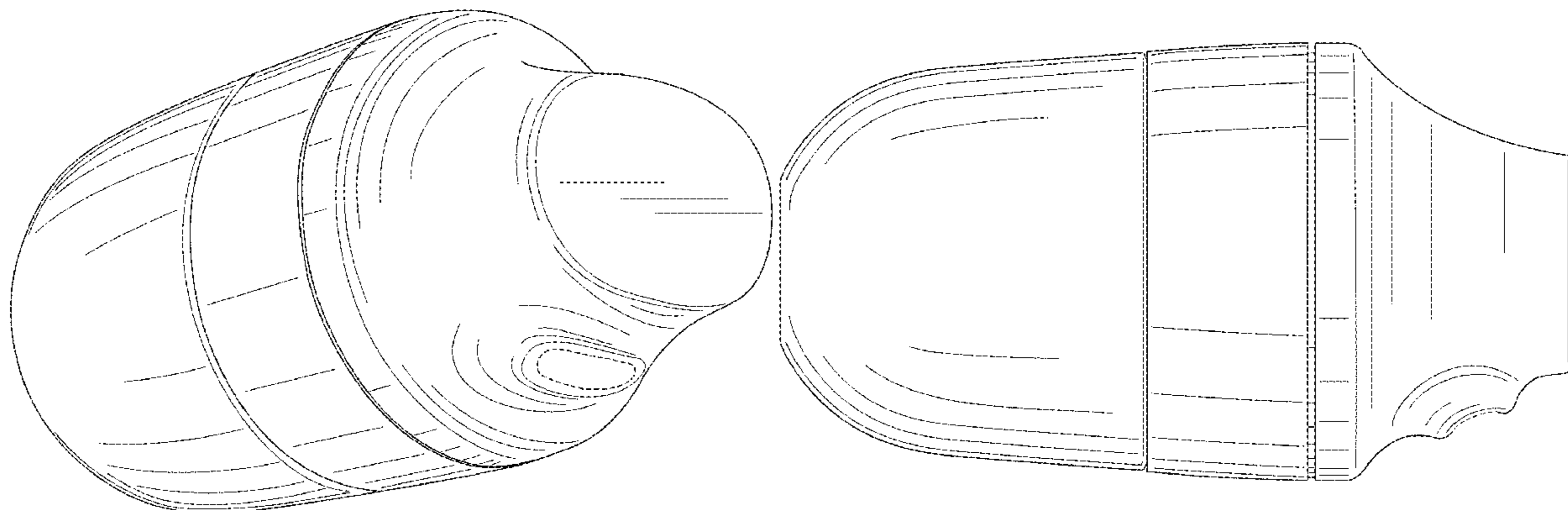


Fig.1

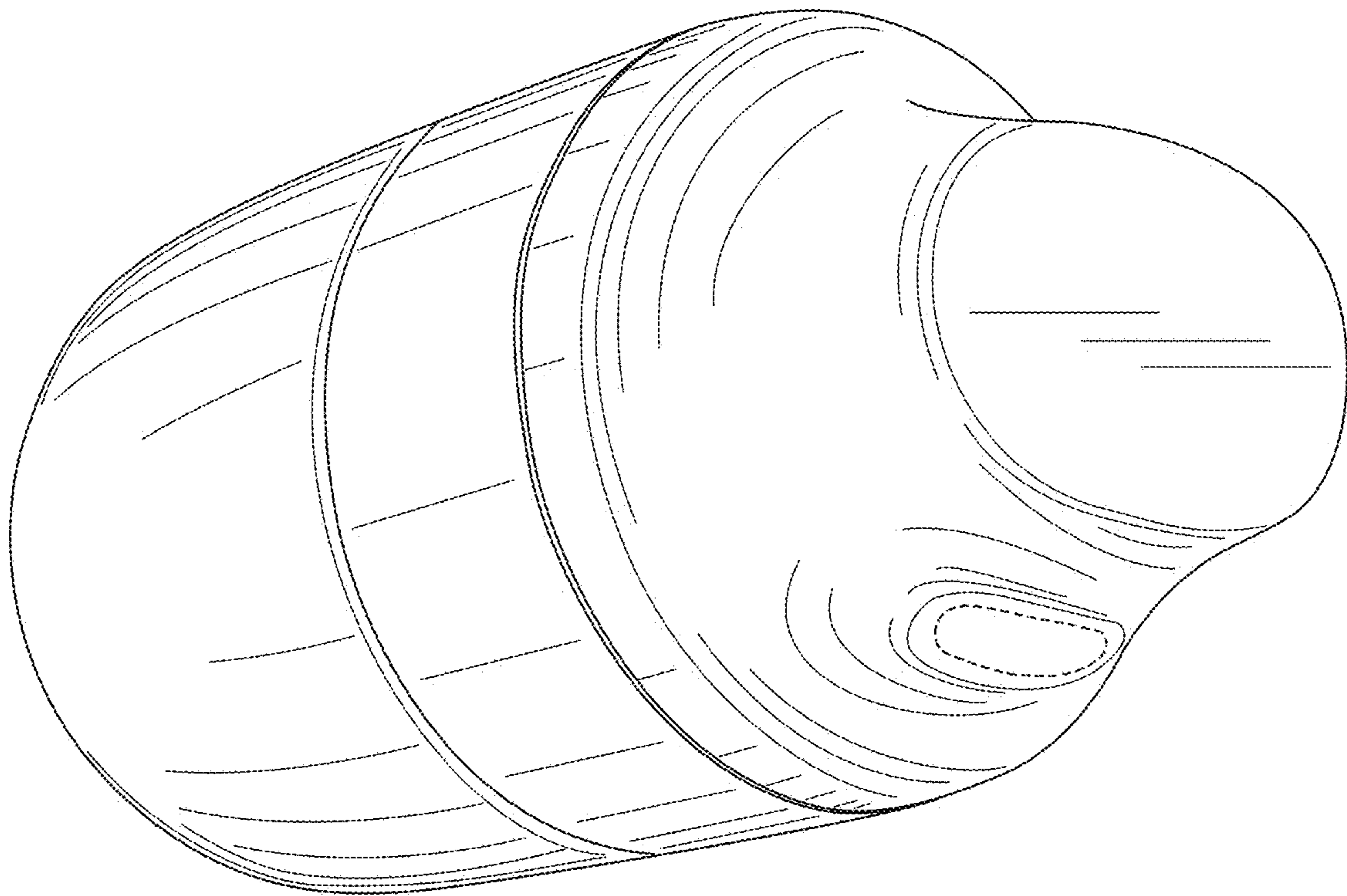


Fig.2

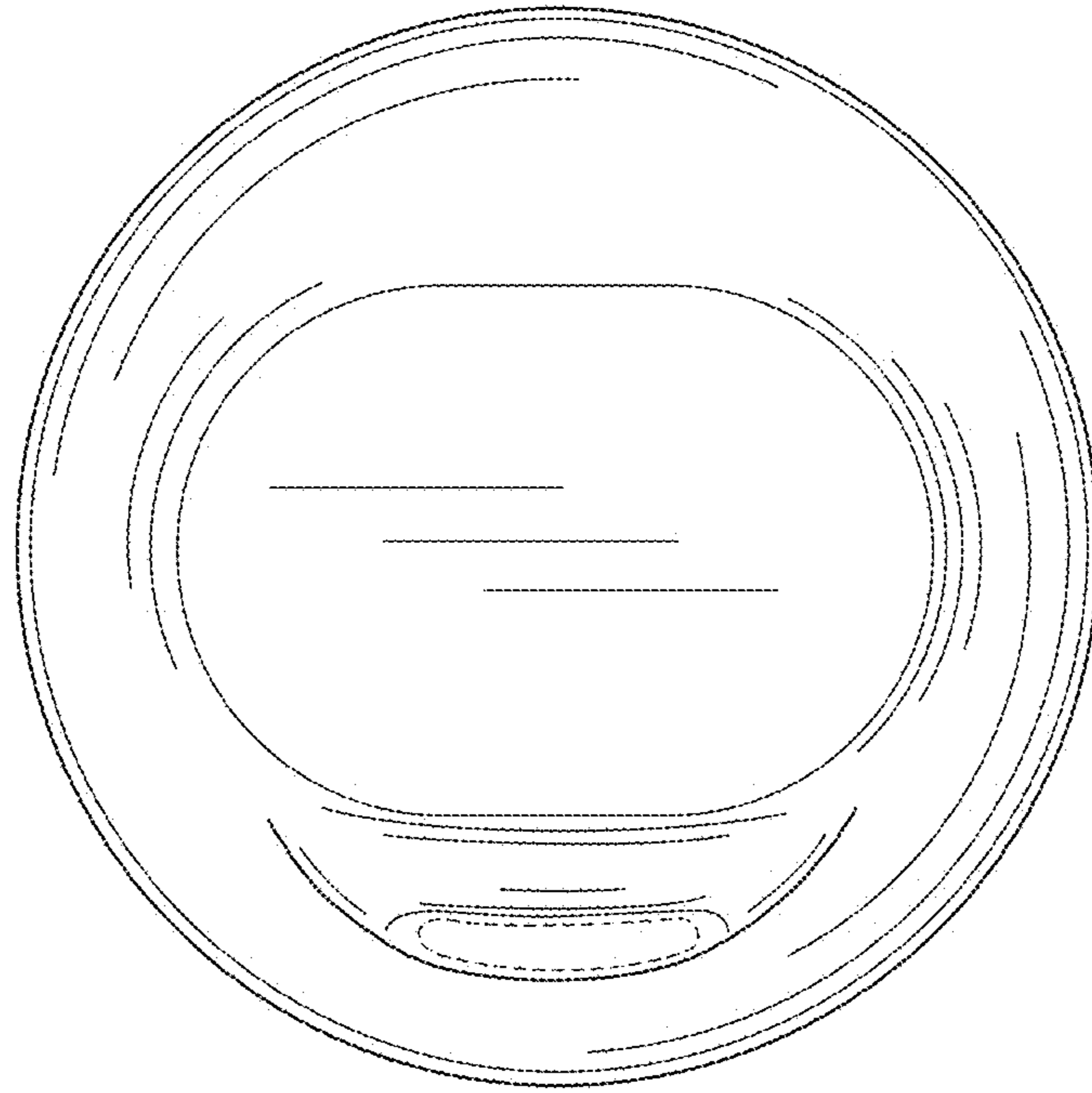


Fig.3

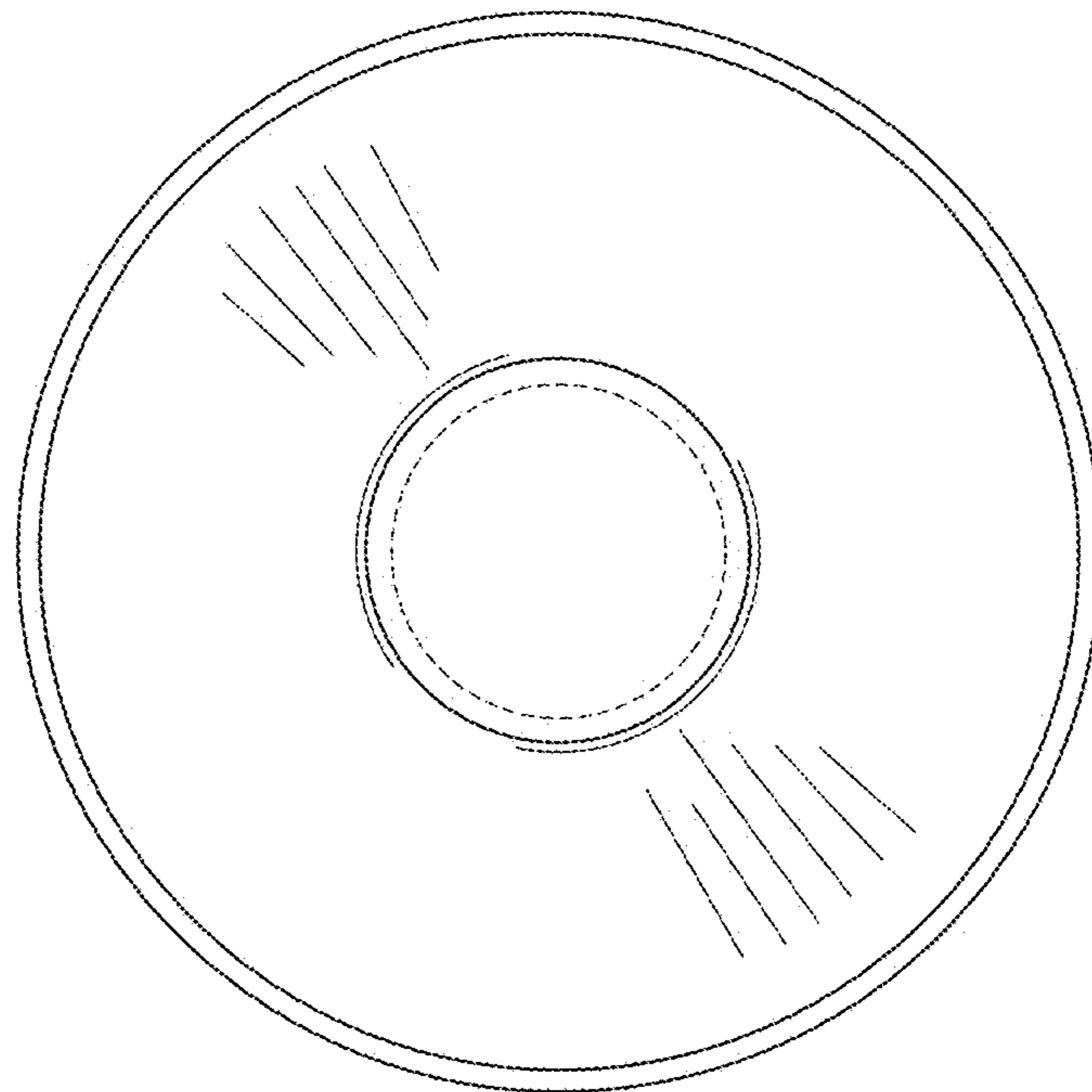


Fig.4

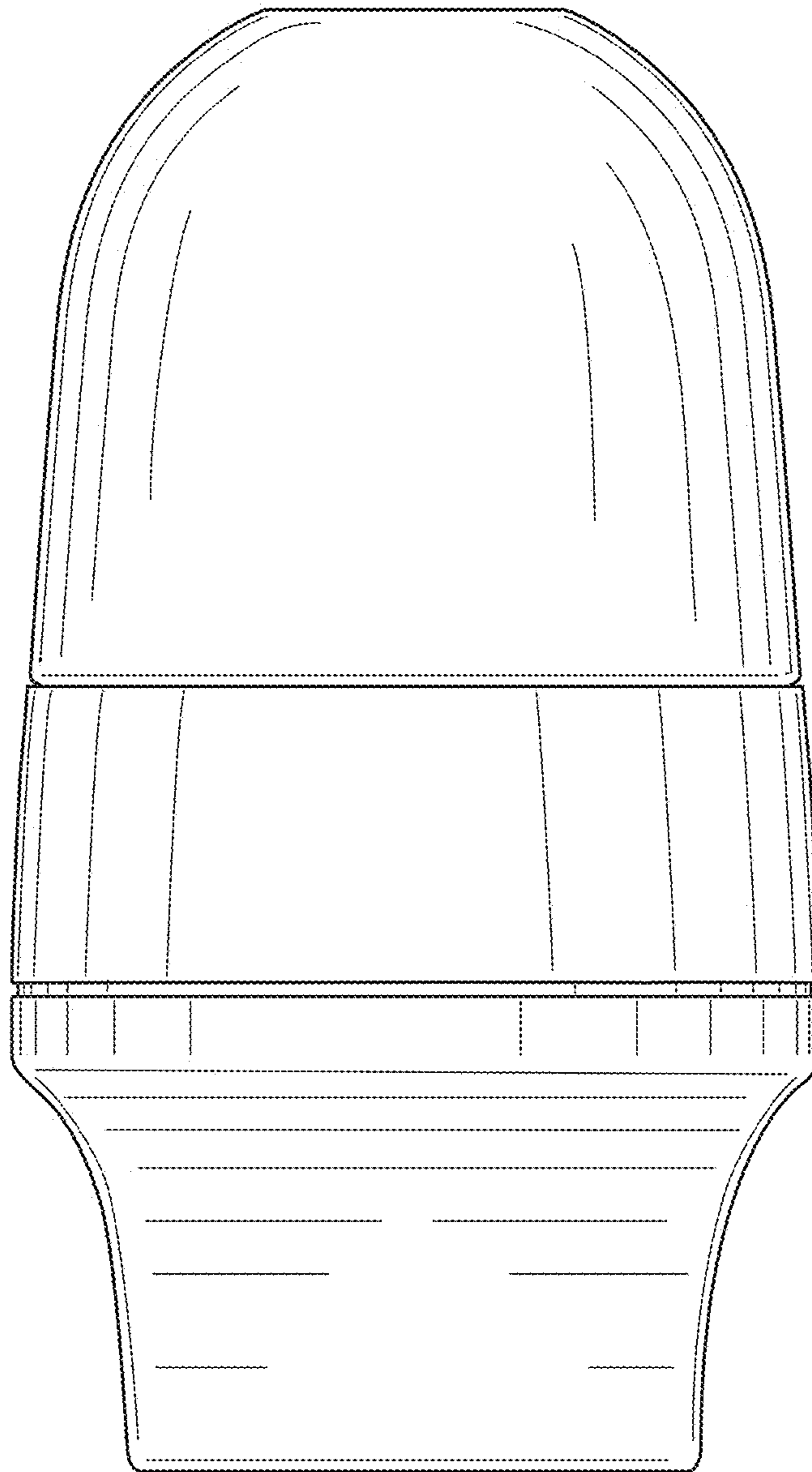


Fig.5

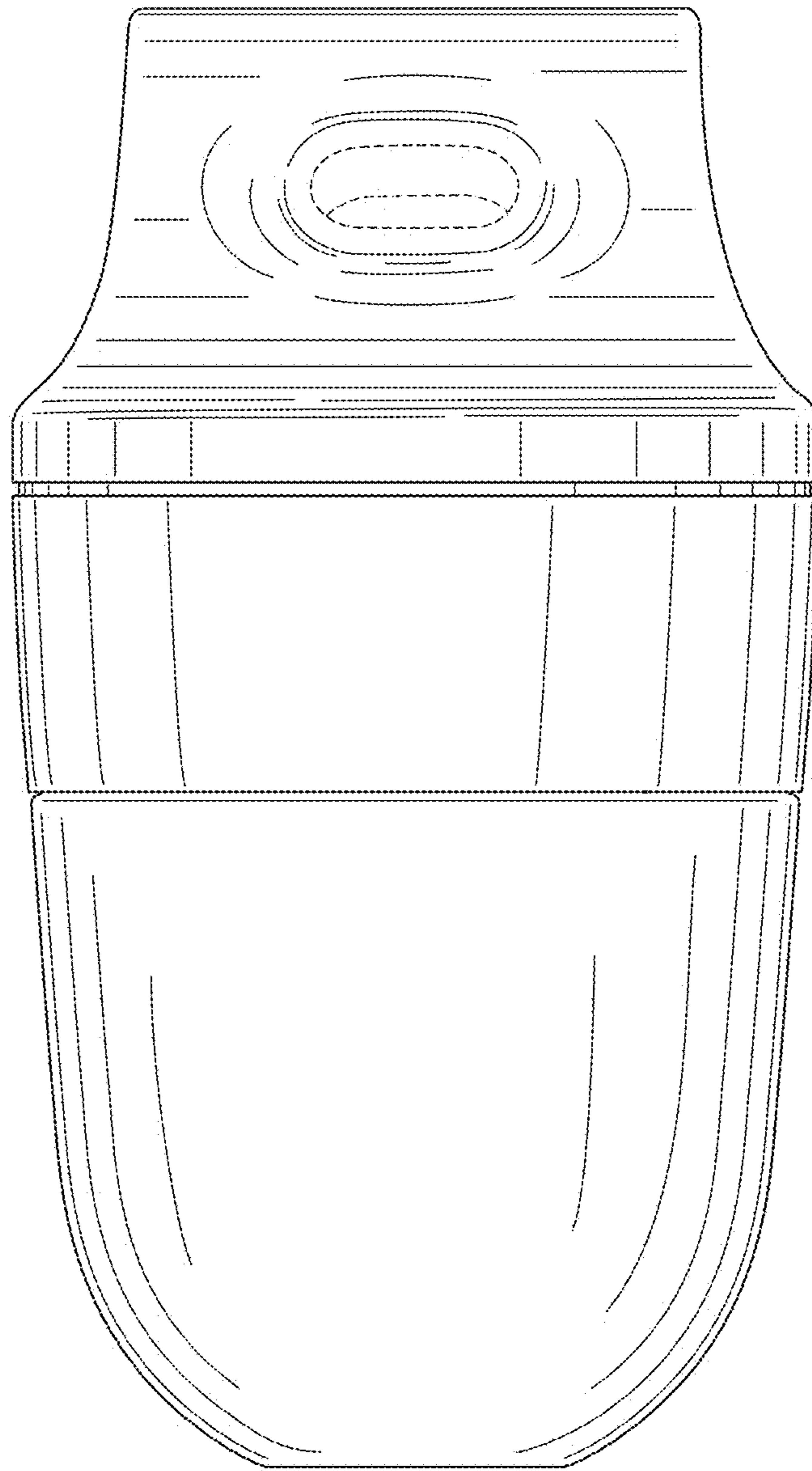


Fig.6

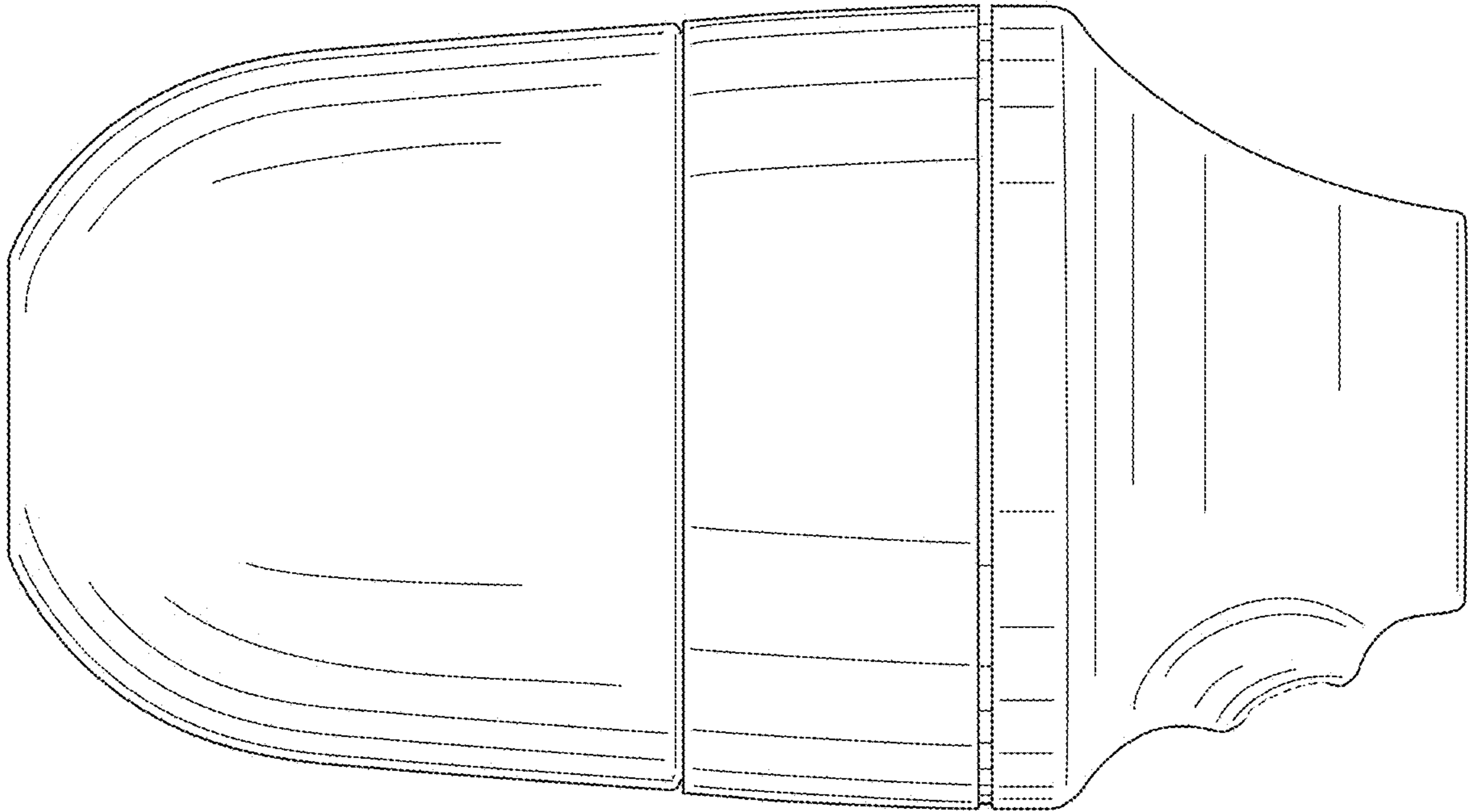


Fig.7

